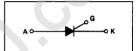
Silicon Controlled Rectifiers Reverse Blocking Triode Thyristors

... fast switching, high-voltage thyristors especially designed for pulse modulator applications.

- High-Voltage Capability from 300 to 600 Volts
- Repetitive Pulse Current to 1000 Amps
- Pulse Repetition as High as 4000 pps
- Current Application Rate as High as 1000 A/μs

MCR1718-5 thru MCR1718-8

SCRs 25 AMPERES RMS 300 thru 600 VOLTS





MAXIMUM RATINGS (T_J = 25°C unless otherwise noted.)

Rating	Symbol	Value	Unit
Peak Repetitive Forward or Reverse Blocking Voltage, Note 1 (T _J = 25 to 125°C, Gate Open) MCR1718-5 -6 -7 -8	VDRM VRRM	300 400 500 600	Volts
Peak Reverse Blocking Voltage (Transient) (Non-Recurrent 5 ms (max)) MCR1718-5 -6 -7 -8	Vrsm	400 500 600 700	Volts
Forward Current RMS	T(RMS)	25	Amps
Peak Forward Surge Current (1-10 µs Pulse Width)	ITSM	1000	Amps
Current Application Rate (up to 1000 A peak)	di/dt	1000	A/μs
Circuit Fusing (t = 8.3 ms)	i ² t	250	A ² s
Dynamic Average Power (T _C = 65°C)	PF(AV)	30	Watts
Peak Gate Power Forward	PGM	20	Watts
Average Gate Power — Forward	PG(AV)	9 1	Watt
Peak Gate Current — Forward	^I GM	5	Amps

Note 1. VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

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MCR1718-5 thru MCR1718-8

MAXIMUM RATINGS — continued

Rating	Symbol	Value	Unit	
Peak Gate Voltage	V _{GM}	10	Volts	
Operating Junction Temperature Range	TJ	-65 to +125	°C	
Storage Temperature Range	T _{stg}	-65 to +150	°C	
Stud Torque		30	in. Ib.	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _θ JC	2	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Forward or Reverse Blocking Current (VAK = Rated VDRM or VRRM, Gate Open) T _J = 25°C T _J = 125°C	IDRM, IRRM	_	_	10 8	μA mA
Forward "On" Voltage (I _{TM} = 25 Adc)	V _{TM}	-	1.1	1.3	Volts
Dynamic Forward On Voltage (I _{GT} = 500 mA, I _{pulse} = 500 A) (1 µs after start (10% pt.) of I _{pulse}) (5 µs after start (10% pt.) of I _{pulse})	VΤM	_	30 5	_	
Gate Trigger Current (Continuous dc) (V _D = 7 Vdc, R _L = 50 Ohms)	^I GT		10	50	mA
Gate Trigger Voltage (Continuous dc) (V _D = 7 Vdc, R _L = 50 Ohms) (V _D = Rated V _{DRM} , R _L = 50 Ohms, T _J = 125°C)	v _{GT}	 0.25	0.8	1.5	Volts
Holding Current (V _D = 7 Vdc, Gate Open) (V _D = 7 Vdc, Gate Open, T _J = 125°C)	Ιн	5 —	15 6	_	mA
Circuit Commutated Turn-Off Time (IF = 500 A, IR = 10 A, dv/dt = 20 V/ μ s VD = Rated VDRM, VR = Rated VRRM) (Conductive Charging Circuit — Circuit dependent)	^t q	_	20	_	μs
Critical Exponential Rate-of-Rise (Gate Open, $T_J = 125^{\circ}C$, $V_D = Rated V_{DRM}$, Exponential Waveform)	dv/dt	_	100	_	V/μs

⁽¹⁾ VDRM for all types can be supplied on a continuous dc basis without incurring damage. Ratings apply for zero or negative gate voltage.